

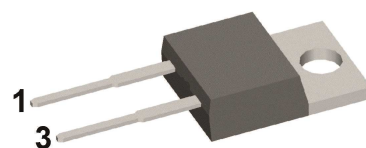
# HiPerFRED

|           |   |       |
|-----------|---|-------|
| $V_{RRM}$ | = | 200 V |
| $I_{FAV}$ | = | 15 A  |
| $t_{rr}$  | = | 35 ns |

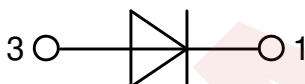
High Performance Fast Recovery Diode  
 Low Loss and Soft Recovery  
 Single Diode

Part number

**DPG15I200PA**



Backside: cathode



## Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low  $I_{rm}$ -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{rm}$  reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

## Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

## Package: TO-220

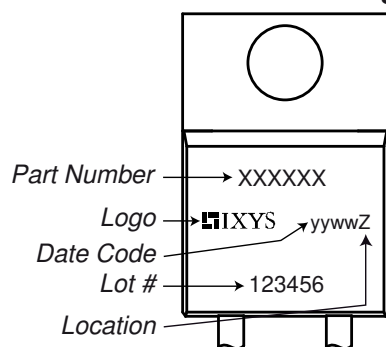
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

## Disclaimer Notice

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).

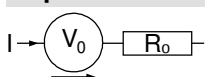
| Fast Diode        |                                              |                                                                                    |                         | Ratings                  |      |      |      |  |
|-------------------|----------------------------------------------|------------------------------------------------------------------------------------|-------------------------|--------------------------|------|------|------|--|
| Symbol            | Definition                                   | Conditions                                                                         |                         | min.                     | typ. | max. | Unit |  |
| V <sub>RSM</sub>  | max. non-repetitive reverse blocking voltage | T <sub>VJ</sub> = 25°C                                                             |                         |                          |      | 200  | V    |  |
| V <sub>RRM</sub>  | max. repetitive reverse blocking voltage     | T <sub>VJ</sub> = 25°C                                                             |                         |                          |      | 200  | V    |  |
| I <sub>R</sub>    | reverse current, drain current               | V <sub>R</sub> = 200 V                                                             | T <sub>VJ</sub> = 25°C  |                          |      | 1    | μA   |  |
|                   |                                              | V <sub>R</sub> = 200 V                                                             | T <sub>VJ</sub> = 150°C |                          |      | 0.08 | mA   |  |
| V <sub>F</sub>    | forward voltage drop                         | I <sub>F</sub> = 15 A                                                              | T <sub>VJ</sub> = 25°C  |                          |      | 1.26 | V    |  |
|                   |                                              | I <sub>F</sub> = 30 A                                                              |                         |                          |      | 1.51 | V    |  |
|                   |                                              | I <sub>F</sub> = 15 A                                                              | T <sub>VJ</sub> = 150°C |                          |      | 1.01 | V    |  |
|                   |                                              | I <sub>F</sub> = 30 A                                                              |                         |                          |      | 1.29 | V    |  |
| I <sub>FAV</sub>  | average forward current                      | T <sub>C</sub> = 145°C<br>rectangular      d = 0.5                                 | T <sub>VJ</sub> = 175°C |                          |      | 15   | A    |  |
| V <sub>F0</sub>   | threshold voltage                            | } for power loss calculation only                                                  |                         | T <sub>VJ</sub> = 175°C  |      | 0.69 | V    |  |
| r <sub>F</sub>    | slope resistance                             |                                                                                    |                         |                          |      | 18   | mΩ   |  |
| R <sub>thJC</sub> | thermal resistance junction to case          |                                                                                    |                         |                          |      | 1.7  | K/W  |  |
| R <sub>thCH</sub> | thermal resistance case to heatsink          |                                                                                    |                         |                          | 0.5  |      | K/W  |  |
| P <sub>tot</sub>  | total power dissipation                      | T <sub>C</sub> = 25°C                                                              |                         |                          |      | 90   | W    |  |
| I <sub>FSM</sub>  | max. forward surge current                   | t = 10 ms; (50 Hz), sine; V <sub>R</sub> = 0 V                                     |                         | T <sub>VJ</sub> = 45°C   |      | 240  | A    |  |
| C <sub>J</sub>    | junction capacitance                         | V <sub>R</sub> = 150 V   f = 1 MHz                                                 |                         | T <sub>VJ</sub> = 25°C   |      | 20   | pF   |  |
| I <sub>RM</sub>   | max. reverse recovery current                | } I <sub>F</sub> = 15 A; V <sub>R</sub> = 130 V<br>-di <sub>F</sub> /dt = 200 A/μs |                         | T <sub>VJ</sub> = 25 °C  |      | 3    | A    |  |
|                   |                                              |                                                                                    |                         | T <sub>VJ</sub> = 125 °C |      | 6.5  | A    |  |
| t <sub>rr</sub>   | reverse recovery time                        |                                                                                    |                         | T <sub>VJ</sub> = 25 °C  |      | 35   | ns   |  |
|                   |                                              |                                                                                    |                         | T <sub>VJ</sub> = 125 °C |      | 55   | ns   |  |

| Package TO-220 |                              |              | Ratings |      |      |      |
|----------------|------------------------------|--------------|---------|------|------|------|
| Symbol         | Definition                   | Conditions   | min.    | typ. | max. | Unit |
| $I_{RMS}$      | RMS current                  | per terminal |         |      | 35   | A    |
| $T_{VJ}$       | virtual junction temperature |              | -55     |      | 175  | °C   |
| $T_{op}$       | operation temperature        |              | -55     |      | 150  | °C   |
| $T_{stg}$      | storage temperature          |              | -55     |      | 150  | °C   |
| <b>Weight</b>  |                              |              |         | 2    |      | g    |
| $M_D$          | mounting torque              |              | 0.4     |      | 0.6  | Nm   |
| $F_C$          | mounting force with clip     |              | 20      |      | 60   | N    |

**Product Marking**

**Part description**

D = Diode  
 P = HiPerFRED  
 G = extreme fast  
 15 = Current Rating [A]  
 I = Single Diode  
 200 = Reverse Voltage [V]  
 PA = TO-220AC (2)

| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | DPG15I200PA     | DPG15I200PA        | Tube          | 50       | 506661   |

**Equivalent Circuits for Simulation**
*\* on die level*
 $T_{VJ} = 175^{\circ}\text{C}$ 

**Fast Diode**
 $V_{0\max}$  threshold voltage

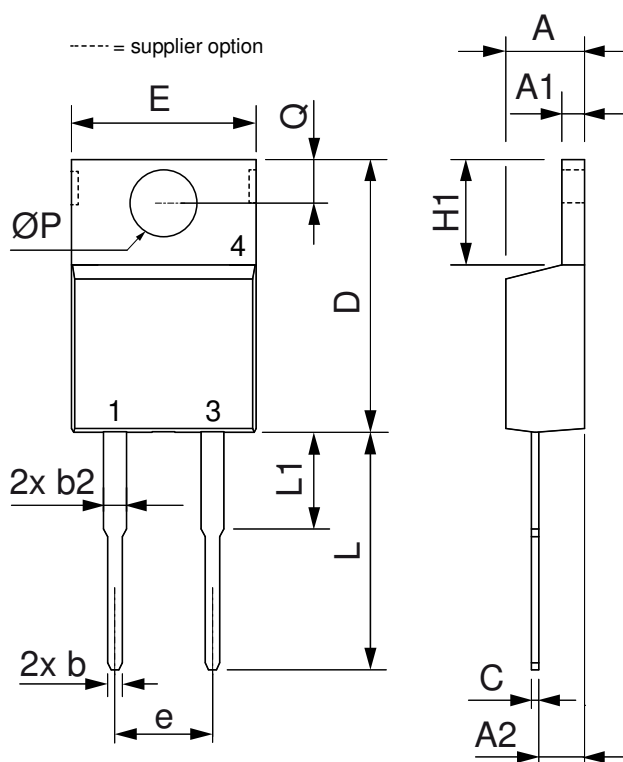
0.69

V

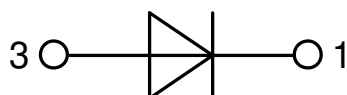
 $R_{0\max}$  slope resistance \*

14.8

mΩ

**Outlines TO-220**


| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 4.32       | 4.82  | 0.170  | 0.190 |
| A1   | 1.14       | 1.39  | 0.045  | 0.055 |
| A2   | 2.29       | 2.79  | 0.090  | 0.110 |
| b    | 0.64       | 1.01  | 0.025  | 0.040 |
| b2   | 1.15       | 1.65  | 0.045  | 0.065 |
| C    | 0.35       | 0.56  | 0.014  | 0.022 |
| D    | 14.73      | 16.00 | 0.580  | 0.630 |
| E    | 9.91       | 10.66 | 0.390  | 0.420 |
| e    | 5.08       | BSC   | 0.200  | BSC   |
| H1   | 5.85       | 6.85  | 0.230  | 0.270 |
| L    | 12.70      | 13.97 | 0.500  | 0.550 |
| L1   | 2.79       | 5.84  | 0.110  | 0.230 |
| ØP   | 3.54       | 4.08  | 0.139  | 0.161 |
| Q    | 2.54       | 3.18  | 0.100  | 0.125 |



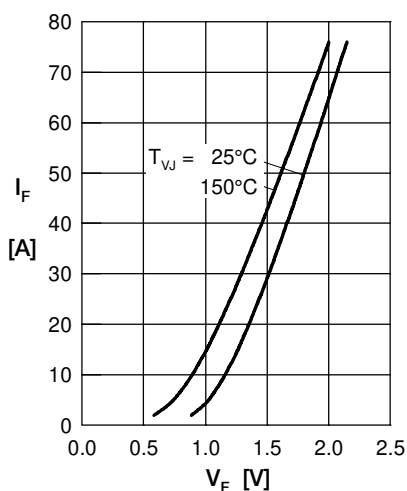
**Fast Diode**


Fig. 1 Forward current  
 $I_F$  versus  $V_F$

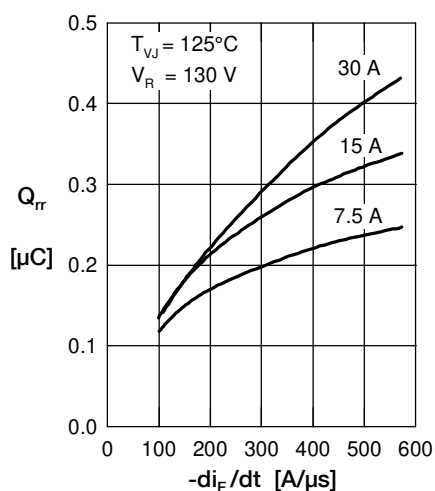


Fig. 2 Typ. reverse recov. charge  
 $Q_{rr}$  versus  $-di_F/dt$

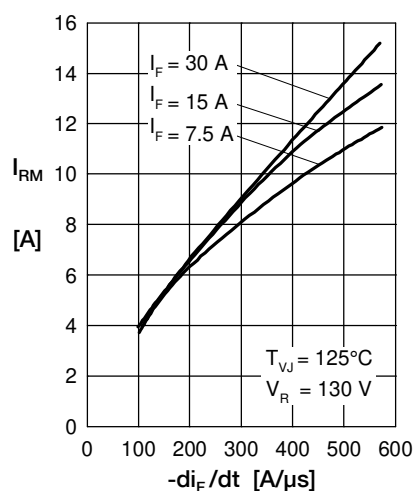


Fig. 3 Typ. peak reverse current  
 $I_{RM}$  versus  $-di_F/dt$

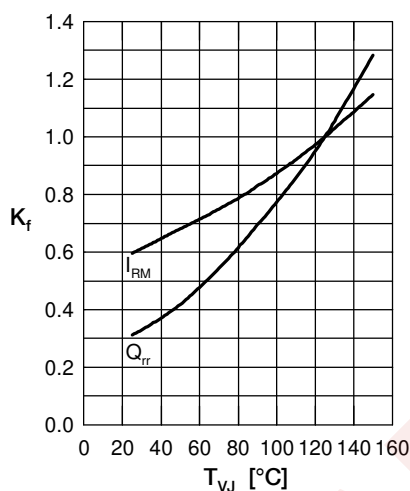


Fig. 4 Typ. dynamic parameters  
 $Q_{rr}$ ,  $I_{RM}$  versus  $T_{VJ}$

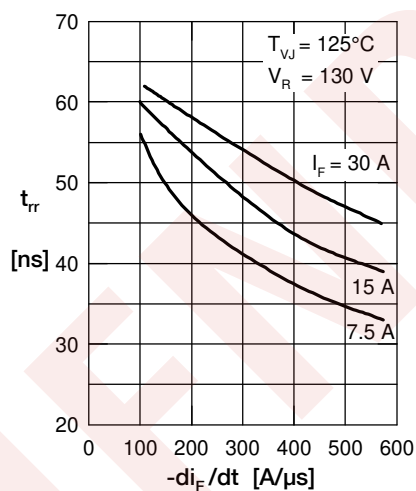


Fig. 5 Typ. recov. time  
 $t_{rr}$  versus  $-di_F/dt$

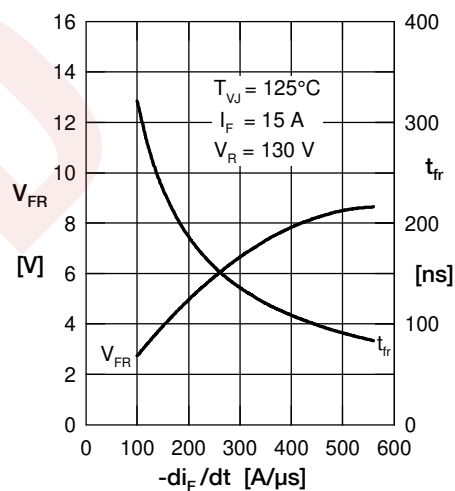


Fig. 6 Typ. peak forward voltage  
 $V_{FR}$  and  $t_{fr}$  versus  $di_F/dt$

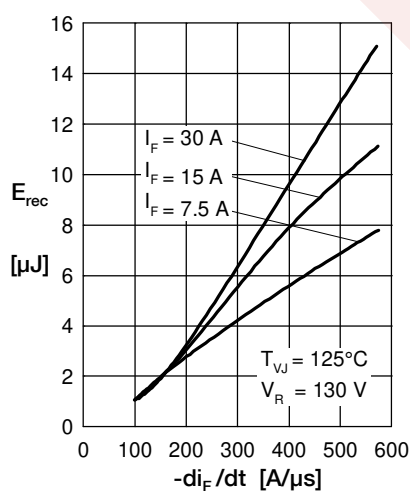


Fig. 7 Typ. recovery energy  
 $E_{rec}$  versus  $-di_F/dt$

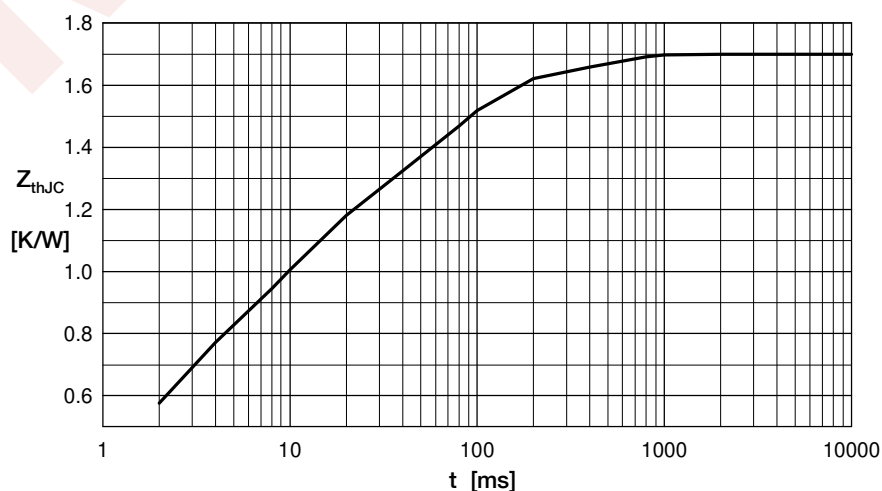


Fig. 8 Transient thermal resistance junction to case